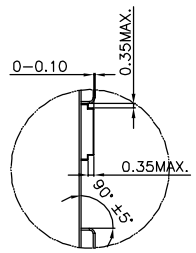
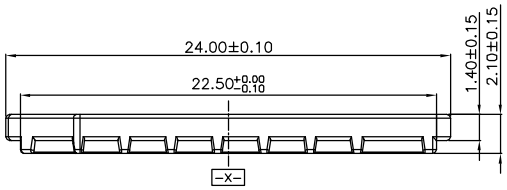
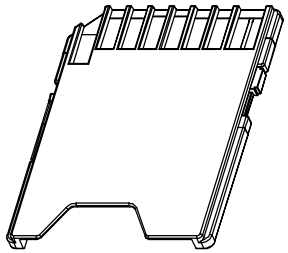
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A	ES.D0601.045	initial	04/18/2006
B	ES.D0604.055	add shell dimension	04/18/2006



DETAIL A





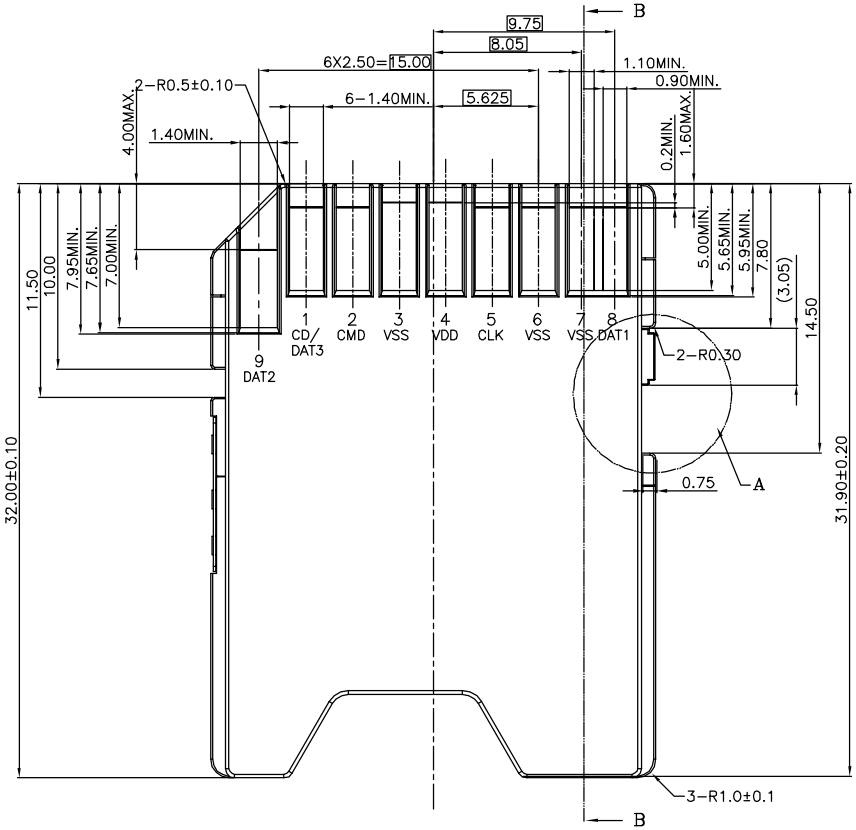
NOTE:

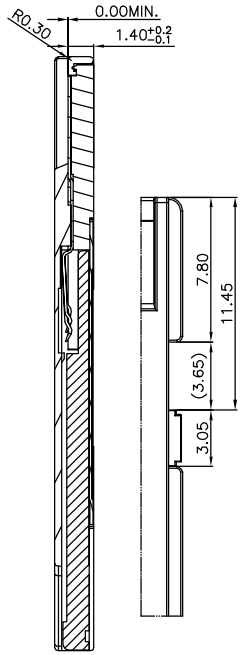
1. Contact Resisitance: 100mΩ Max.
2. Dielectric Withstanding Voltage: 500VAC Max With i Minute
3. Insulation Resisitance: 1000 MΩ Min.
4. Current Rating: 1 A AC/DC Max. Rated Valtage: 500 V RMS Min.
5. Mini SD Card extraction force: 1.5N MIN.
6. Durability: 10,000 mating cycles.
7. Operating Temperature: −25℃ ~ +85℃
8. Storage Temperature: −45℃ ~ +85℃

THE PART NUMBER:

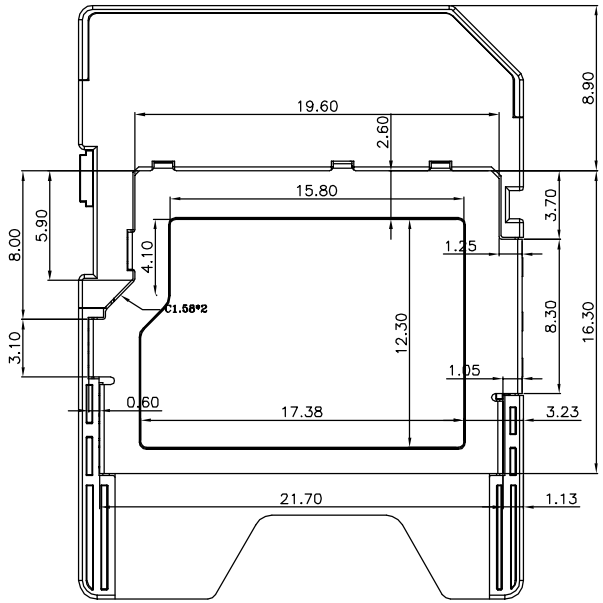
106-00120-**

10: Selective gold 1u" on contact area over nickel plated 80u"
11: Selective gold 3u" on contact area over nickel plated 80u"
12: Selective gold 5u" on contact area over nickel plated 80u"
13: Selective gold 10u" on contact area over nickel plated 80u"
14: Selective gold 15u" on contact area over nickel plated 80u"
15: Selective gold 30u" on contact area over nickel plated 80u"
16: Selective gold 50u" on contact area over nickel plated 80u"





SEC B-B



GENERAL	TOLERANCE	FILE.NO.	106-00120	PART.NO.	106-00120-**	DRAWN	WYX	MATERIAL		SCALE	NO SCALE
X.±0.50	x.°± 5°	REV.	B	TITLE	MINISD Adapter(shell)	CHECKED	Terry	DATE	04/18/2006	UNIT	MM
.X±0.38	.x°± 2°	SIZE		SHEET	1 OF 1	APPROVED	Jeffrey	Amphenol Shouhmin Industry			
.XX±0.25	.xx± 1°	A4									